

5.0 AMP SURFACE MOUNT SCHOTTKY BARRIER RECTIFIERS

Features:

- * Low forward voltage drop
- * High current capability
- * High reliability
- * High surge current capability
- * Epitaxial construction

Mechanical Data:

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Lead: Axial leads, solderable per MIL-STD-202, method 208 guranteed
- * Polarity: Color band denotes cathode end
- * Mounting position: Any
- * Weight: 0.093 grams
- * Both normal and Pb free product are available:
- * Normal: 80~95%Sn, 5~20%Pb
- * Pb free: 99 Sn above can meet Rohs enviroment substance directive request

SMBF



MARKING:SS52BF/S52B - SS520BF/S520B

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwies specified.
 Single phase half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

TYPE NUMBER	SS52BF	SS54BF	SS56BF	SS58BF	SS510BF	SS515BF	SS520BF	UNITS
Maximum Recurrent Peak Reverse Voltage	20	40	60	80	100	150	200	V
Maximum RMS Voltage	14	28	42	56	70	105	140	V
Maximum DC Blocking Voltage	20	40	60	80	100	150	200	V
Maximum Average Forward Rectified Current See Fig. 1	5.0							A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	150							A
Maximum Instantaneous Forward Voltage at 5.0A °	0.55	0.70	0.85				V	
Maximum DC Reverse Current Ta=25 C _a at Rated DC Blocking Voltage Ta=100 C	0.2			20				mA
Typical Junction Capacitance (Note 1)	380							°pF
Typical Thermal Resistance R JA (Note 2)	10							C/W
Operating Temperature Range Tj	-65 — +150							°C
Storage Temperature Range TSTG	-65 — +150							C

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. Thermal Resistance Junction to Ambient.

RATING AND CHARACTERISTIC CURVES (SS52BF THRU SS520BF)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

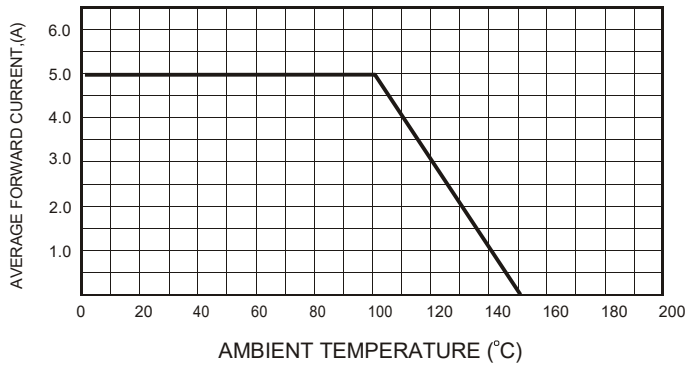


FIG.2-TYPICAL FORWARD CHARACTERISTICS

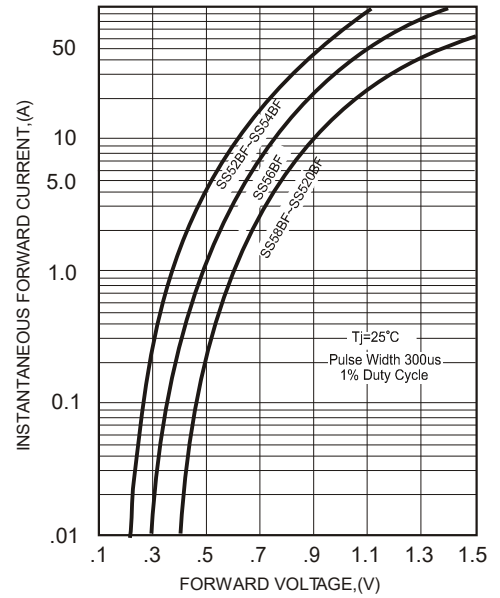


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

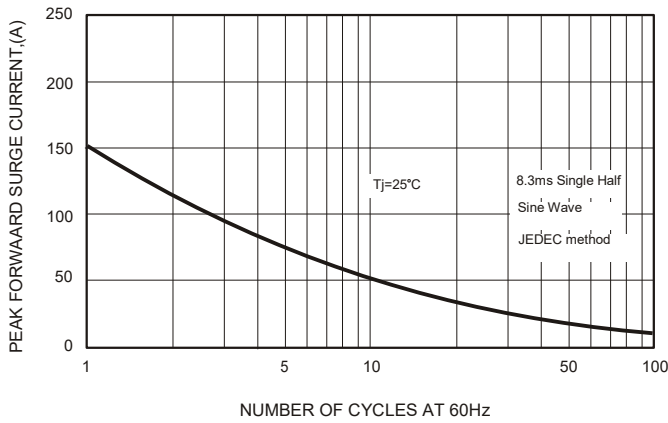


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

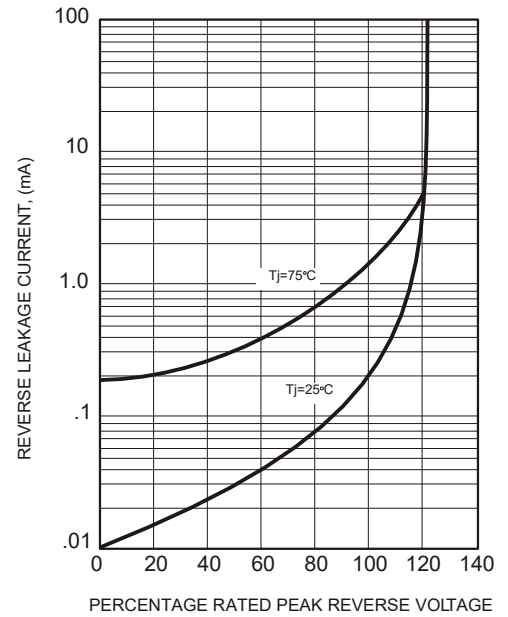
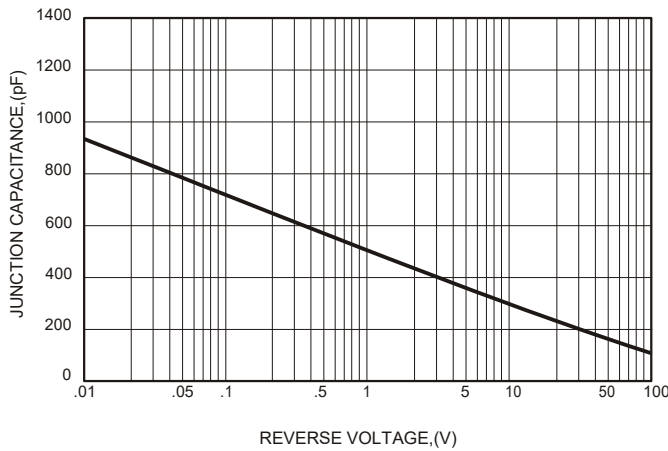
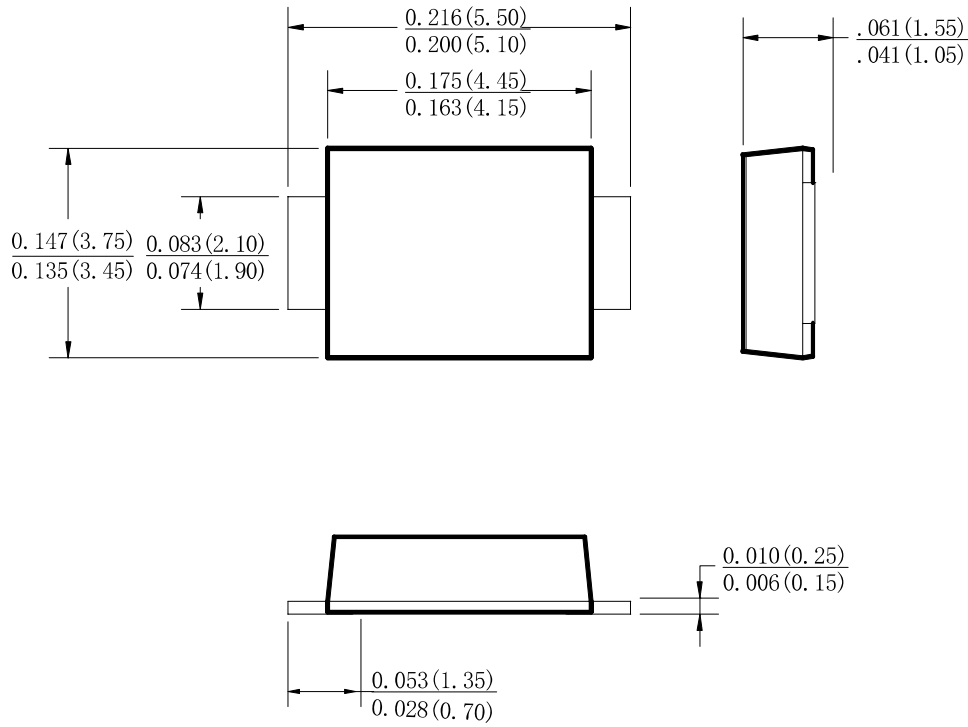


FIG.4-TYPICAL JUNCTION CAPACITANCE

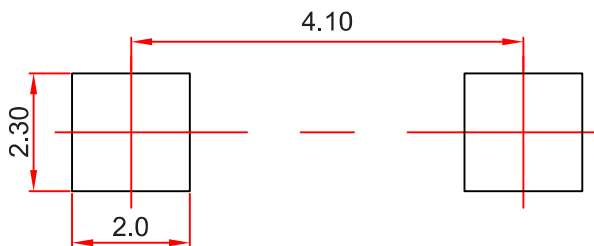


SMBF Package Outline Dimensions



Dimensions in inches and (millimeters)

SMBF Suggested Pad Layout

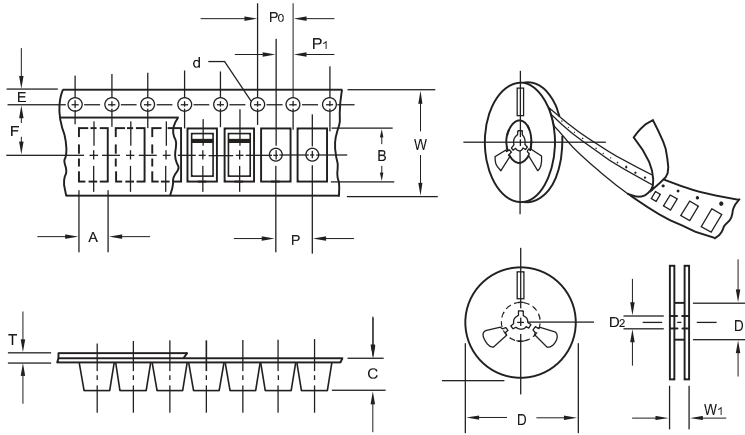


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

Reel Taping Specifications For Surface Mount Devices- SMBF

Packing information



unit:mm

Item	Symbol	Tolerance	SMBF
Carrier width	A	0.1	3.81
Carrier length	B	0.1	5.61
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D1	min	50.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P_0	0.1	4.00
Embossment center	P_1	0.1	2.00
Overall tape thickness	T	0.1	0.30
Tape width	W	0.3	12.00
Reel width	W1	1.0	12.30

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA, (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMBF	13"	5,000	4.0	10,000	190*190*41	330	365*365*360	80,000	14.0